

MN863440

TFT LCD Gate Driver with 200, 240, 256, or 263 Outputs

■ Overview

The MN863440 is a TFT LCD gate driver with 200, 240, 256, or 263 2-value outputs. The number of outputs can be selected to be any one of these by the user.

This IC implements 2-value (pseudo 3-value) drive, and provides a cascade-connection pin to support large-screen displays. It is provided in a TCP package.

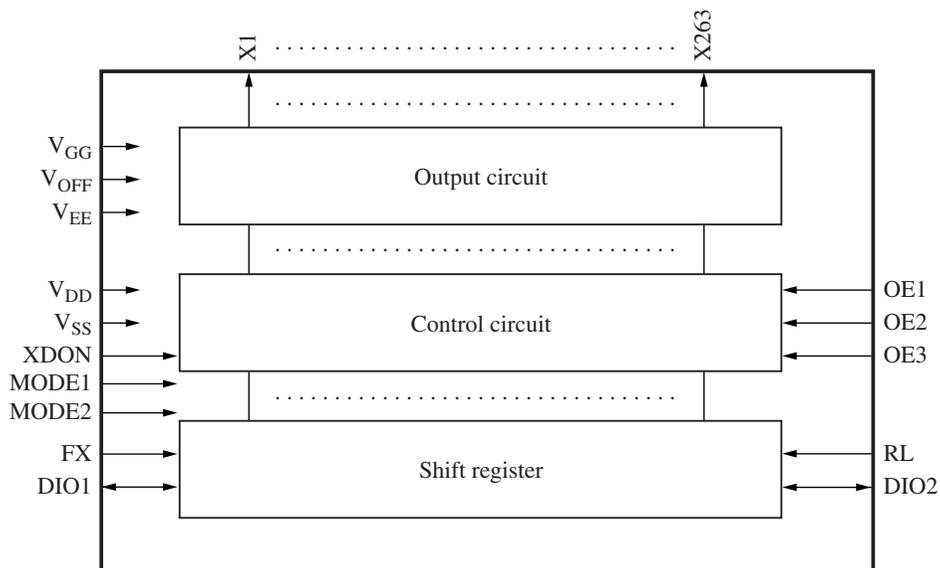
■ Features

- Adopts a bidirectional shift register system
- Provides an expansion pin so that the number of output pins can be increased.
- Pulse width modulation function (OE1 to OE3)
- Driver operating frequency: 500 kHz (maximum)
- LCD drive voltage: $V_{EE} + 40$ V (maximum)
- Driver output levels: 2 levels (The low level can be modified.)
- Supports TCP mounting.

■ Applications

- LCD TV sets

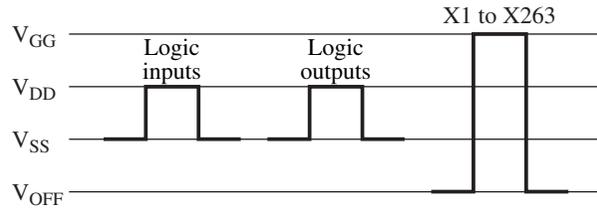
■ Block Diagram



■ Functional Descriptions

1. LCD drive voltages

The MN863440 can provide LCD drive voltages that are negative relative to logic ground.



2. Operation

The MN863440 outputs either the display level (V_{GG}) or the off level (V_{OFF}) from the LCD driver outputs (X1 to X263) under control of the shift data and the OE input signal.

The data shift direction can be controlled with the shift direction switching pin (RL).

The DIO input signal is acquired on the rising edge of FX. The shift register operates and the drive voltages are output with this timing as well. The DIO output is synchronized with the falling edge of FX.

RL	Start pulse input	Data transfer direction	Carry pulse output
RL = High	DIO1	X1 → X263	DIO2
RL = Low	DIO2	X263 → X1	DIO1

■ Functional Descriptions (continued)

3. OE function

The outputs can be forced to the display off level regardless of the data in the shift register in sets consisting of every third output pin by setting the OE1, OE2, and OE3 pins to the high level.

This function operates asynchronously with the FX pin.

200 output TCP	240 output TCP	256 output TCP	263 output TCP
MODE1 = Low	MODE1 = Low	MODE1 = High	MODE1 = High
MODE2 = Low	MODE2 = High	MODE2 = Low	MODE2 = High
X1 (OE1)	X1 (OE1)	X1 (OE1)	X1 (OE1)
X2 (OE2)	X2 (OE2)	X2 (OE2)	X2 (OE2)
X3 (OE3)	X3 (OE3)	X3 (OE3)	X3 (OE3)
⋮	⋮	⋮	⋮
X98 (OE2)	⋮	⋮	X98 (OE2)
X99 (OE3)	⋮	⋮	X99 (OE3)
X100 (OE1)	⋮	⋮	X100 (OE1)
	⋮	⋮	⋮
	X118 (OE1)	⋮	X118 (OE1)
	X119 (OE2)	⋮	X119 (OE2)
	X120 (OE3)	⋮	X120 (OE3)
		⋮	⋮
		X126 (OE3)	X126 (OE3)
		X127 (OE1)	X127 (OE1)
		X128 (OE2)	X128 (OE2)
			X129 (OE3)
			X130 (OE1)
			X131 (OE2)
			X132 (OE3)
			X133 (OE1)
			X134 (OE2)
			X135 (OE3)
		X136 (OE3)	X136 (OE1)
		X137 (OE1)	X137 (OE2)
		X138 (OE2)	X138 (OE3)
		⋮	⋮
	X144 (OE1)	⋮	X144 (OE3)
	X145 (OE2)	⋮	X145 (OE1)
	X146 (OE3)	⋮	X146 (OE2)
	⋮	⋮	⋮

■ Functional Descriptions (continued)

3. OE function (continued)

200 output TCP	240 output TCP	256 output TCP	263 output TCP
X164 (OE2)	∴ ∴	∴ ∴	X164 (OE2)
X165 (OE3)	∴ ∴	∴ ∴	X165 (OE3)
X166 (OE1)	∴ ∴	∴ ∴	X166 (OE1)
∴ ∴	∴ ∴	∴ ∴	∴ ∴
X261 (OE3)	X261 (OE1)	X261 (OE2)	X261 (OE3)
X262 (OE1)	X262 (OE2)	X262 (OE3)	X262 (OE1)
X263 (OE2)	X263 (OE3)	X263 (OE1)	X263 (OE2)

Here, (OEn) indicates which of OE1, OE2, and OE3 is the related signal.

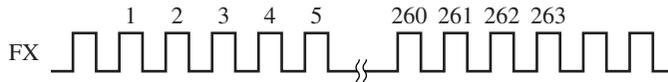
4. XDON function

The outputs can be set to the output the display on potential (V_{GG}) regardless of the states of the OEn pins and the shift register data by setting the XDON pin to the low level.

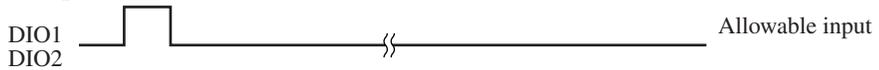
This function operates asynchronously with the FX pin. This pin is pulled up.

5. Carry input (DIO1, DIO2)

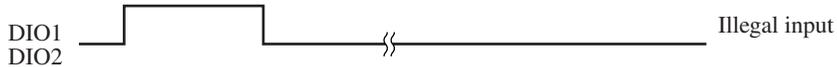
The waveform input to the carry input must meet the following conditions.



1) Single pulse width input



2) Input with a width of 2 pulses or longer



3) Double pulse input

Pulse spacing: An odd number



4) Double pulse input

Pulse spacing: An even number

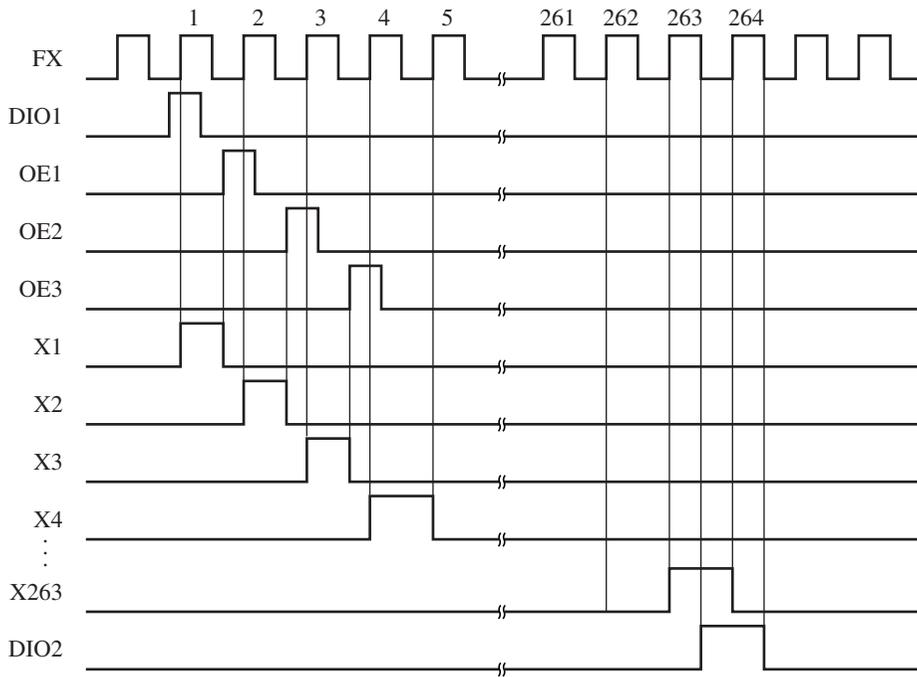


■ Pin Descriptions

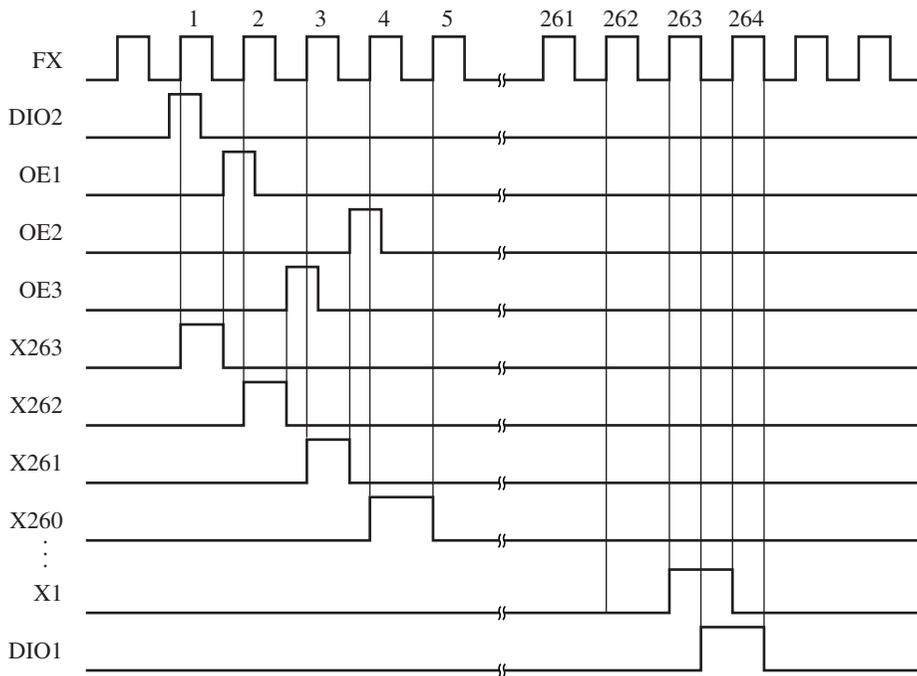
Pin Name	I/O	Function	Description															
FX	I	Shift register clock input	The start pulse is acquired and the shift register shifted on the FX rising edge. The carry pulse is output on the FX falling edge.															
RL	I	Right shift/left shift selection input	RL = High: X1 → X263 (Left shift) RL = Low: X263 → X1 (Right shift)															
DIO1 DIO2	I/O	Start pulse input and carry pulse output	<table border="1"> <thead> <tr> <th></th> <th>DIO1</th> <th>DIO2</th> </tr> </thead> <tbody> <tr> <td>RL = High</td> <td>I</td> <td>O</td> </tr> <tr> <td>RL = Low</td> <td>O</td> <td>I</td> </tr> </tbody> </table>		DIO1	DIO2	RL = High	I	O	RL = Low	O	I						
	DIO1	DIO2																
RL = High	I	O																
RL = Low	O	I																
MODE1 MODE2	I	Output pin count switching inputs	<table border="1"> <thead> <tr> <th>MODE1</th> <th>MODE2</th> <th>LCD outputs</th> </tr> </thead> <tbody> <tr> <td>High</td> <td>High</td> <td>263</td> </tr> <tr> <td>High</td> <td>Low</td> <td>256</td> </tr> <tr> <td>Low</td> <td>High</td> <td>240</td> </tr> <tr> <td>Low</td> <td>Low</td> <td>200</td> </tr> </tbody> </table>	MODE1	MODE2	LCD outputs	High	High	263	High	Low	256	Low	High	240	Low	Low	200
MODE1	MODE2	LCD outputs																
High	High	263																
High	Low	256																
Low	High	240																
Low	Low	200																
OE1 to OE3	I	Display signal enable/disable inputs	When OEn is high, the corresponding LCD drive output pins are set to the display off potential (V_{OFF}) asynchronously with the FX pin, regardless of the states of the shift register and other input data. See 3. OE function in the Functional Descriptions section.															
X1 to X263	O	LCD drive outputs	These pins output, in synchronization with the FX rising edge, either the V_{GG} or the V_{OFF} voltage level according to the shift register data and the states of the OE1 to OE3, DIO1, and DIO2 pins.															
V_{GG}	Power	LCD drive output block power supply LCD drive supply 1	Power supply for the level shifters and output buffers. This supply is also used for the LCD drive voltage.															
V_{OFF}	Power	LCD drive supply 2	Supplies an LCD drive voltage.															
V_{EE}	Power	V_{GG} system ground																
V_{DD}	Power	3 V system logic power supply	Power supply used for the 3 V system logic circuits.															
V_{SS}	Power	V_{DD} system ground																

■ Basic Waveforms

1. RL = High, left shift, MODE1, MODE2 = high

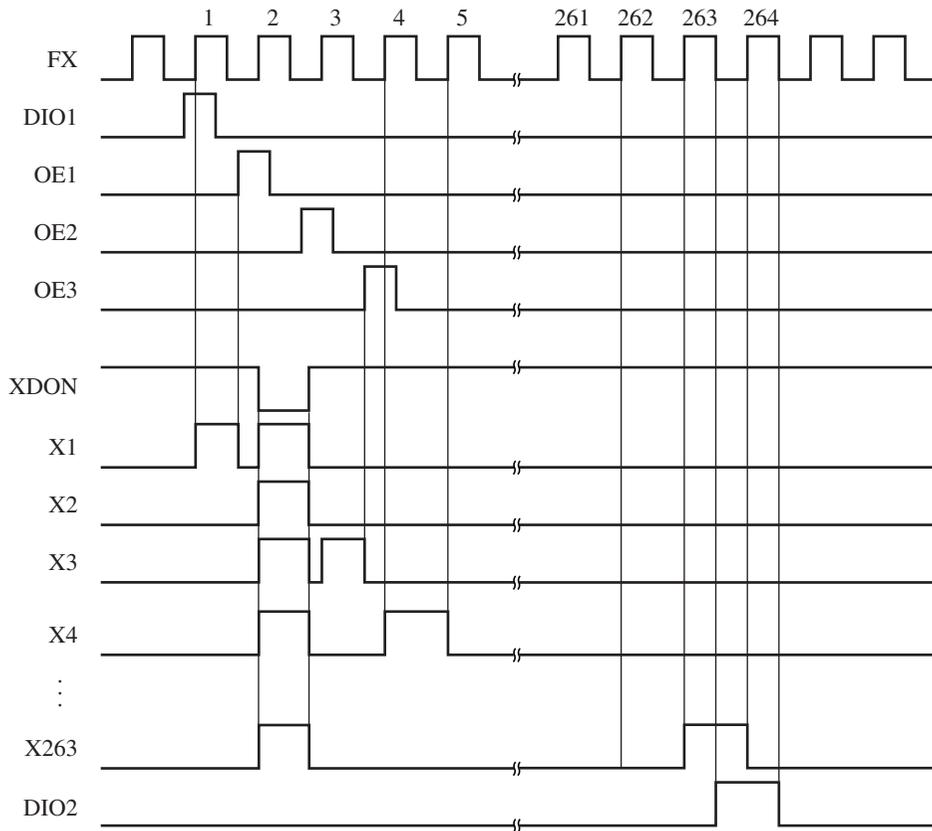


2. RL = Low, right shift, MODE1, MODE2 = high



■ XDON Usage Example

- RL = High, left shift, MODE1, MODE2 = high



■ Electrical Characteristics

1. Absolute Maximum Ratings at $V_{SS} = 0\text{ V}$

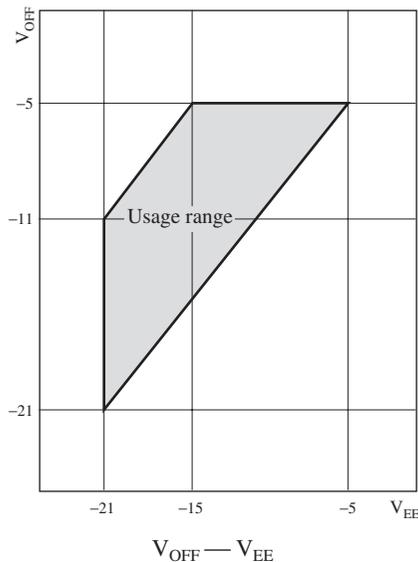
Item	Symbol	Rating	Unit
Supply voltage 1	V_{DD}	- 0.3 to +4.5	V
Supply voltage 2	V_{GG}	V_{EE} to $V_{EE} +44$	V
Drive voltage	V_{OFF}	$V_{EE} - 0.3$ to $V_{GG} +0.3$	V
Supply voltage 3	V_{EE}	- 24 to +0.3	V
Digital input voltage	V_I	- 0.3 to $V_{DD} +0.3$	V
Operating and storage temperature range	T_a	-30 to +85	°C
Operating ambient temperature	T_{opr}	-20 to +75	°C
Storage temperature	T_{stg}	-55 to +120	°C

Note) 1. The absolute maximum ratings are limit values for stresses applied to the chip so that the chip will not be destroyed. Operation is not guaranteed within these ranges.

2. The operating and storage temperature range is the temperature range over which the chip will not be damaged even if operated. Note that performance is not guaranteed throughout this range.
3. These ratings are guaranteed values when the standard Panasonic package is used.
4. The power supply voltages must meet the condition $V_{EE} \leq V_{GG}$ at all times, including when power is being applied, during operation, and when power is being turned off.
5. When power is applied, certain sequences of power application can cause large currents to flow and permanently damage the IC. To avoid this problem, first apply V_{DD} , and then, after V_{DD} has reached 90% of its set voltage, apply V_{EE} , V_{GG} , and V_{OFF} .

2. Operating Conditions at $V_{SS} = 0\text{ V}$, $T_{opr} = -20^\circ\text{C}$ to $+75^\circ\text{C}$

Item	Symbol	Condition	Min	Typ	Max	Unit
Operating supply voltage 1	V_{DD}		2.3	—	3.6	V
Operating supply voltage 2	V_{GG}		10	—	$V_{EE} +40$	V
Operating supply voltage 3	V_{EE}		-21	—	-5	V
Operating supply voltage 3	V_{OFF}	$-21 \leq V_{EE} \leq -15$	V_{EE}	—	$V_{EE} +10$	V
		$-15 < V_{EE} < -5$	V_{EE}	—	-5	



Note) These ratings are guaranteed values when the standard Panasonic package is used.

■ Electrical Characteristics (continued)

3. DC Characteristics at $V_{SS} = 0\text{ V}$, $T_{opr} = -20^{\circ}\text{C}$ to $+75^{\circ}\text{C}$

Item	Symbol	Condition	Min	Typ	Max	Unit
Operating supply current (V_{DD})	I_{DD}	$f_{FX} = 15.7\text{ kHz}$ $f_{DIO} = 60\text{ Hz}$ $V_{DD} = 3.0\text{ V}$	—	—	800	μA
Operating supply current (V_{GG})	I_{GG}	$V_{OFF} = -15\text{ V}$ $V_{GG} = 15\text{ V}$ With no output load	—	—	300	μA
Standby mode current consumption (V_{DD})	I_{DS}	In standby mode $V_{DD} = 3.0\text{ V}$	—	—	600	μA
Standby mode current consumption (V_{GG})	I_{GS}	$V_{OFF} = -15\text{ V}$ $V_{GG} = 15\text{ V}$	—	—	100	μA

1) Input pins RL, FX, OE1 to OE3, MODE1, MODE2

High-level input voltage	V_{IH1}		$0.8 \times V_{DD}$	—	V_{DD}	V
Low-level input voltage	V_{IL1}		0	—	$0.2 \times V_{DD}$	V
Input leakage current	I_{LI1}		-10	—	10	μA

2) Pulled up input pins XDON

High-level input voltage	V_{IH2}		$0.8 \times V_{DD}$	—	V_{DD}	V
Low-level input voltage	V_{IL2}		0	—	$0.2 \times V_{DD}$	V
Pull-up resistance	R_{PU}	$V_{DD} = 3.0\text{ V}$	10	—	100	$\text{k}\Omega$

3) I/O pins DIO1, DIO2

High-level input voltage	V_{IH3}		$0.8 \times V_{DD}$	—	V_{DD}	V
Low-level input voltage	V_{IL3}		0	—	$0.2 \times V_{DD}$	V
High-level output voltage	V_{OH}	$-100\ \mu\text{A}$	$V_{DD} - 0.4$	—	—	V
Low-level output voltage	V_{OL}	$100\ \mu\text{A}$	—	—	0.4	V

4) LCD drive voltage input pin V_{OFF}

Input leakage current	V_{LI1}		-50	—	50	μA
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5) LCD drive output pins X1 ~ X263

Output leakage current	I_{LO1}		-50	—	50	μA
Output on resistance	RON- V_{GG}	$V_{GG} = 15\text{ V}$ $V_{OFF} = -15\text{ V}$ $V_{OM} = V_{GG} - 0.5\text{ V}$ V_{OM} is the X1 to X263 applied voltage.	200	400	800	Ω
	RON- V_{OFF}	$V_{GG} = 15\text{ V}$ $V_{EE} = -15\text{ V}$ $V_{OFF} = -15\text{ V}$ $V_{OM} = V_{OFF} + 0.5\text{ V}$ V_{OM} is the X1 to X263 applied voltage.	200	400	800	

Note) These ratings are guaranteed values when the standard Panasonic package is used.

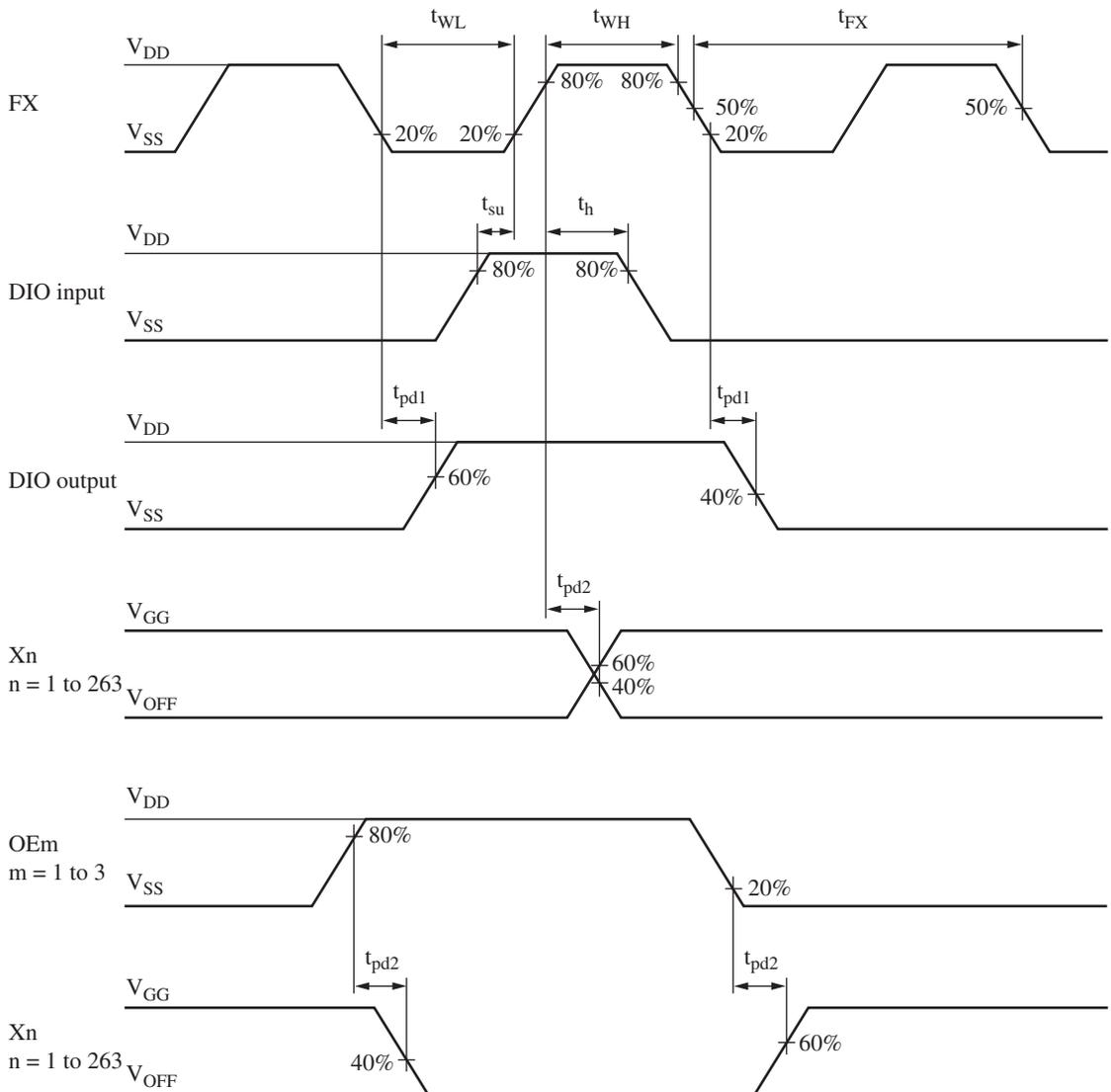
■ Electrical Characteristics (continued)

4. AC Characteristics at $V_{SS} = 0\text{ V}$, $T_{opr} = -20^{\circ}\text{C}$ to $+75^{\circ}\text{C}$

Item	Symbol	Condition	Min	Typ	Max	Unit
Clock period	t_{FX}		2.0	—	—	μs
Clock high-level pulse width	t_{WH}		700	—	—	ns
Clock low-level pulse width	t_{WL}		700	—	—	ns
DIO data setup time	t_{su}		300	—	—	ns
DIO data hold time	t_h		300	—	—	ns
DIO output delay time	t_{pd1}	$CL = 50\text{ pF}$	—	—	600	ns
Xn output delay time	t_{pd2}	$CL = 300\text{ pF}$	—	—	800	ns

Note) These ratings are guaranteed values when the standard Panasonic package is used.

• AC Characteristics Timing Charts



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